

Replacement Page 1, 1st Paragraph

BACKGROUND OF THE INVENTION

The invention relates to a method for the machining of materials by combining one machining tool with at least one additional machining tool, wherein at least one machining tool employs laser radiation.

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SUMMARY OF THE INVENTION

This object is solved for a method of the aforementioned kind in accordance with the invention in that a synchronized modulation, i.e., synchronous or asynchronous modulation, of the first machining tool is carried out when combining it with the additional machining tool that is also pulse-modulated.

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BRIEF DESCRIPTION OF THE DRAWINGS

Further features and advantages of the invention result from the following description of several embodiments as well as the drawings to which reference is being had. It is shown in:

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DESCRIPTION OF PREFERRED EMBODIMENTS

Based on Figs. 1 and 2, methods and devices for hybrid processing of materials by combining a machining tool with at least one additional machining tool will be explained, wherein at least one machining tool employs laser radiation.